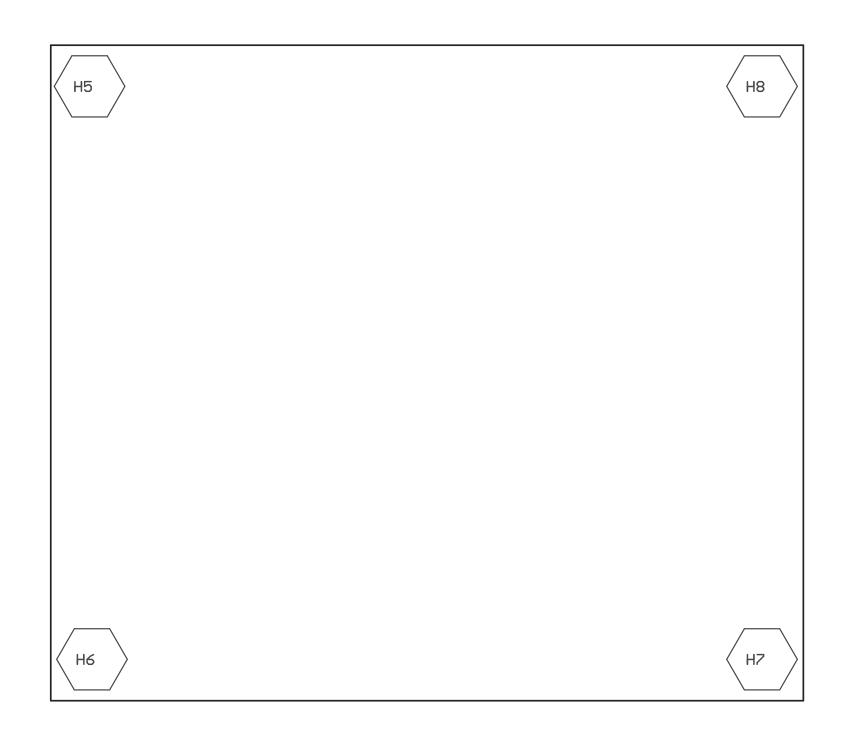


## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00760	REV: E1	SUN REV:	: Not In VersionControl
	TID #: TIDA-00760			
PLOT NAME = Top Assembly Drawing	GENERATED : 3/15/2	2016 3: 26: 05	PM	TEXAS INSTRUMENTS



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00760 R	REV: E1 SUN	REV: Not In VersionControl
	TID #: TIDA-00760		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 3/15/2016	3:26:08 PM	TEXAS INSTRUMENTS

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